



**Features** 

#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>SSS</sub>	Rss(on) Typ	Is <sub>Max</sub> T <sub>A</sub> = +25°C
14.5V	$2.36m\Omega$ @ V <sub>GS</sub> = $3.8V$	24.4A

#### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (Rss(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

#### **Applications**

- **Battery Management**
- Load Switch
- **Battery Protection**

# Case: X4-DSN3118-6

Terminal Connections: See Diagram Below

CSP with Footprint 3.05mm x 1.77mm Height = 0.11mm for Low Profile **ESD Protection of Gate** 

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu or NiAu. Solderable per MIL-STD-202. Method 208 @4)

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)

manufactured in IATF 16949 certified facilities), please

https://www.diodes.com/quality/product-definitions/

contact us or your local Diodes representative.

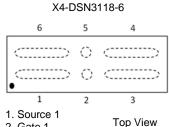
For automotive applications requiring specific change control

(i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and

Weight: 0.0012 grams (Approximate)

**Mechanical Data** 



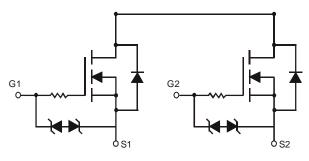


2. Gate 1

3. Source 1 4. Source 2

5. Gate 2

6. Source 2



**Equivalent Circuit** 

### **Ordering Information (Note 4)**

Part Number	Case	Packaging
DMN12M3UCA6-7	X4-DSN3118-6	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# **Marking Information**



J3 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: H = 2020) M or  $\overline{M}$  = Month (ex. 9 = September)

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Source-Source Voltage	V <sub>SSS</sub>	14	V		
Gate-Source Voltage			Vgss	±8	V
Continuous Source Current (Note 5) V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	Is	24.4 19.6	А
Continuous Source Current (Note 5) V <sub>GS</sub> = 2.5V	Is	16.4 13.1	А		
Pulsed Source Current (Note 6)			Ism	100	А

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	1.10	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 7)	$R_{\theta JA}$	114.1	°C/W
Power Dissipation (Note 5)	PD	2.47	W
Thermal Resistance, Junction to Ambient @TA = +25°C (Note 5)	Reja	50.7	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

#### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Source-Source Breakdown Voltage	BVsss	14.5	_	_	V	VGS = 0V, IS = 1mA	
Zero Gate Voltage Drain Current TJ = +25°C	Isss	_	_	1	μΑ	Vss = 9.6V, Vgs = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 8V, V_{SS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.35	0.8	1.4	<b>V</b>	Vss = 10V, Is = 1.41mA	
		1.5	2.27	2.75		$V_{GS} = 4.5V, I_{S} = 6A$	
Static Source-Source On-Resistance	D	1.6	2.36	2.85	<b>m</b> O	V <sub>G</sub> S = 3.8V, I <sub>S</sub> = 6A	
Static Source-Source Off-Resistance	Rss(on)	1.7	2.54	3.95	mΩ	$V_{GS} = 3.1V, I_{S} = 6A$	
		1.9	2.9	6.1		V <sub>G</sub> S = 2.5V, I <sub>S</sub> = 6A	
Diode Forward Voltage	Vss	_	0.69	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 6A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	3062	4593	pF	V 40V V 0V	
Output Capacitance	Coss	_	758	1137		Vss = 10V, $Vgs = 0V$ , $f = 1kHz$	
Reverse Transfer Capacitance	Crss	_	198	297		I = IKIIZ	
Total Gate Charge	Qg	_	45.7	68.6			
Gate-Source Charge	Qgs	_	8.3	12.5	nC	Vss = 8V, Vgs = 4V,	
Gate-Drain Charge	Qgd	_	16.0	24.0	iiC	Is = 6A	
Gate Charge at V <sub>TH</sub>	Q <sub>g(th)</sub>	_	4.5	6.8			
Turn-On Delay Time	tD(ON)	_	1005	1508			
Turn-On Rise Time	t <sub>R</sub>	_	2186	3279	ns	$V_{SS} = 8V$ , $V_{GS} = 4V$ ,	
Turn-Off Delay Time	t <sub>D</sub> (OFF)	_	2643	3965		I <sub>S</sub> = 6A	
Turn-Off Fall Time	tF	_	4193	6290			

Notes:

- 5. Device mounted on FR-4 material with 1-inch² (6.45-cm²), 2-oz. (0.071-mm thick) Cu.
- Repetitive rating, pulse width limited by junction temperature.
   Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to production testing.



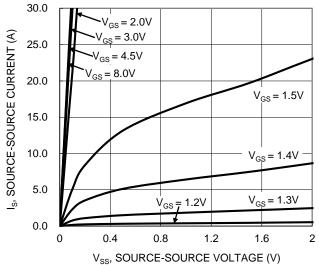


Figure 1. Typical Output Characteristic

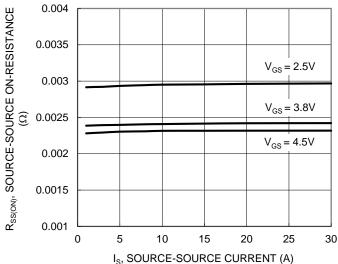


Figure 3. Typical On-Resistance vs. Source Current and Gate Voltage

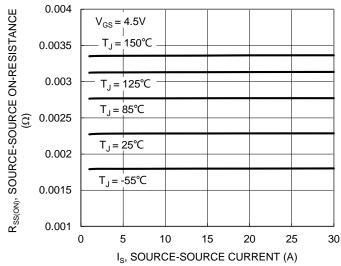


Figure 5. Typical On-Resistance vs. Source Current and Junction Temperature

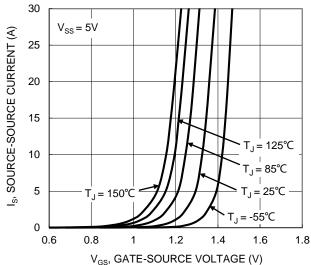


Figure 2. Typical Transfer Characteristic

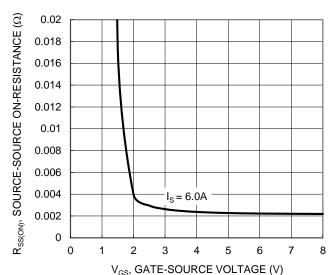


Figure 4. Typical Transfer Characteristic

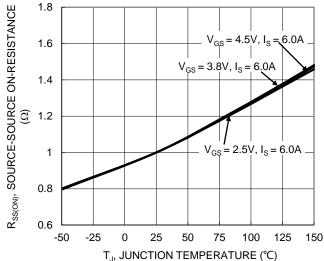


Figure 6. On-Resistance Variation with Junction Temperature



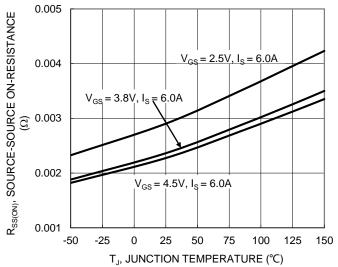
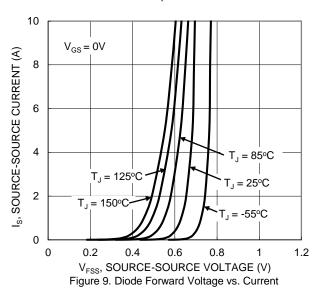
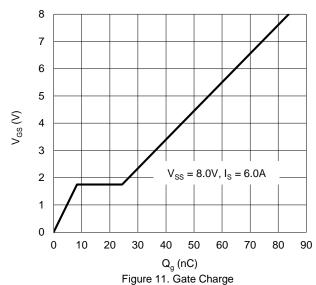


Figure 7. On-Resistance Variation with Junction Temperature





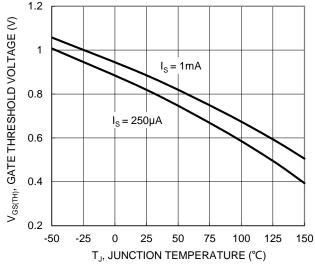
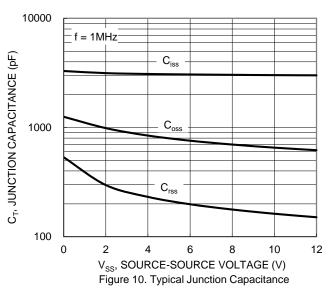
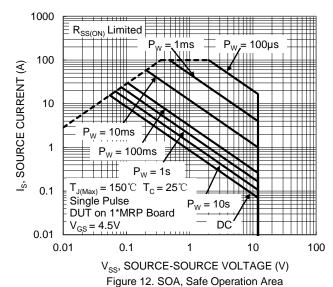


Figure 8. Gate Threshold Variation vs. Junction Temperature







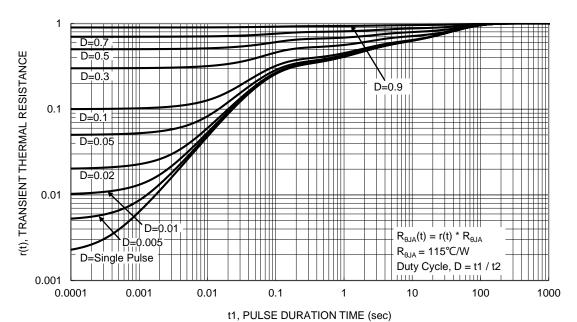


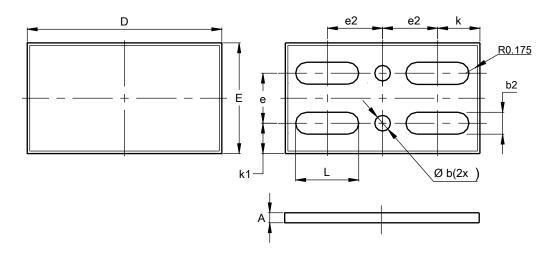
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X4-DSN3118-6

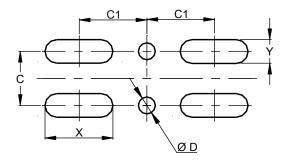


X4-DSN3118-6						
Dim	Min	Max	Тур			
Α	0.09	0.16	0.11			
b			0.25			
b2	0.32	0.38	0.35			
D	3.00	3.10	3.05			
Е	1.72	1.82	1.77			
е			0.800			
e2			0.878			
k			0.648			
k1			0.485			
L	0.975	1.035	1.005			
All Dimensions in mm						

#### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X4-DSN3118-6



Dimensions	Value		
Dillielisions	(in mm)		
С	0.800		
C1	0.878		
D	0.250		
Х	1.005		
Y	0.350		



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